



## F5N50

Power MOSFET

### 5.0A, 500V N-CHANNEL POWER MOSFET

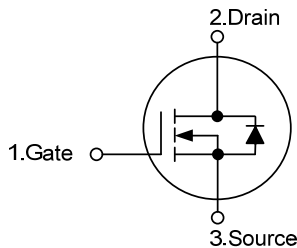
#### DESCRIPTION

The UTC **F5N50** is an N-Channel enhancement mode silicon gate power MOSFET with Fast Body Diode, is designed high voltage, high speed power switching applications such, is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

#### FEATURES

- \*  $R_{DS(ON)} \leq 1.6 \Omega @ V_{GS}=10V, I_D=2.5A$
- \* Fast body diode MOSFET technology
- \* 100% avalanche tested
- \* High switching speed

#### SYMBOL



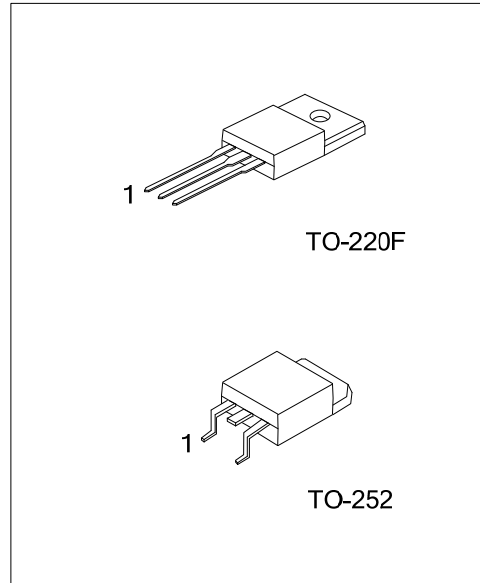
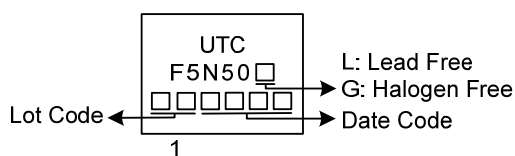
#### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
F5N50L-TF3-T	F5N50G-TF3-T	TO-220F	G	D	S	Tube
F5N50L-TN3-R	F5N50G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>F5N50G-TF3-T</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TF3: TO-220F, TN3: TO-252</p> <p>(3) G: Halogen Free and Lead Free</p>
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#### MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	500	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$I_D$	5	A
	Pulsed (Note 2)	$I_{DM}$	20	A
Avalanche Current (Note 2)		$I_{AR}$	5	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	200	mJ
	Repetitive (Note 2)	$E_{AR}$	7.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220F	$P_D$	38	W
	TO-252		54	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3.  $L = 16\text{mH}$ ,  $I_{AS} = 5\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 5\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
	TO-252		110	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220F	$\theta_{JC}$	3.25	$^\circ\text{C}/\text{W}$
	TO-252		2.13	$^\circ\text{C}/\text{W}$

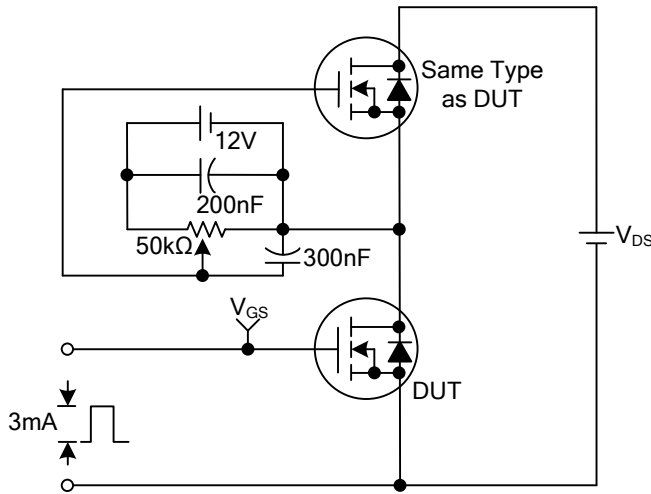
■ ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
<b>OFF CHARACTERISTICS</b>								
Drain-Source Breakdown Voltage		$BV_{DSS}$	$I_D=250\mu\text{A}$ , $V_{GS}=0\text{V}$	500			V	
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $I_D=250\mu\text{A}$		0.5		$\text{V}/^\circ\text{C}$	
Drain-Source Leakage Current		$I_{DSS}$	$V_{DS}=500\text{V}$ , $V_{GS}=0\text{V}$			1	$\mu\text{A}$	
			$V_{DS}=400\text{V}$ , $T_C=125^\circ\text{C}$			10		
Gate- Source Leakage Current	Forward	$I_{GSS}$	$V_{GS}=30\text{V}$ , $V_{DS}=0\text{V}$			100	nA	
	Reverse		$V_{GS}=-30\text{V}$ , $V_{DS}=0\text{V}$			-100	nA	
<b>ON CHARACTERISTICS</b>								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$	1.5		3.5	V	
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	$V_{GS}=10\text{V}$ , $I_D=2.5\text{A}$		1.25	1.6	$\Omega$	
<b>DYNAMIC PARAMETERS</b>								
Input Capacitance		$C_{ISS}$	$V_{GS}=0\text{V}$ , $V_{DS}=25\text{V}$ , $f=1.0\text{MHz}$		480	625	pF	
Output Capacitance		$C_{OSS}$				80	105	pF
Reverse Transfer Capacitance		$C_{RSS}$				15	20	pF
<b>SWITCHING PARAMETERS</b>								
Total Gate Charge		$Q_G$	$V_{GS}=10\text{V}$ , $V_{DS}=50\text{V}$ , $I_D=1.3\text{A}$ (Note 1, 2)		20	24	nC	
Gate to Source Charge		$Q_{GS}$				4		nC
Gate to Drain Charge		$Q_{GD}$				5		nC
Turn-ON Delay Time		$t_{D(ON)}$	$V_{DD}=30\text{V}$ , $I_D=0.5\text{A}$ , $R_G=25\Omega$ (Note 1, 2)		30	50	ns	
Rise Time		$t_R$				50	70	ns
Turn-OFF Delay Time		$t_{D(OFF)}$				145	100	ns
Fall-Time		$t_F$				70	105	ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>								
Maximum Continuous Drain-Source Diode Forward Current		$I_S$				5	A	
Maximum Pulsed Drain-Source Diode Forward Current		$I_{SM}$				20	A	
Drain-Source Diode Forward Voltage		$V_{SD}$	$I_S=5\text{A}$ , $V_{GS}=0\text{V}$			1.4	V	
Reverse Recovery Time		$t_{rr}$	$I_S=5\text{A}$ , $V_{GS}=0\text{V}$ ,		120		ns	
Reverse Recovery Charge		$Q_{rr}$	$dI_F/dt=50\text{A}/\mu\text{s}$ (Note 1)		0.15		$\mu\text{C}$	

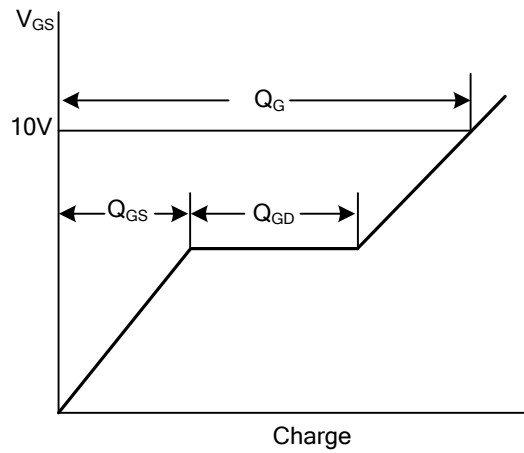
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$

2. Essentially independent of operating temperature

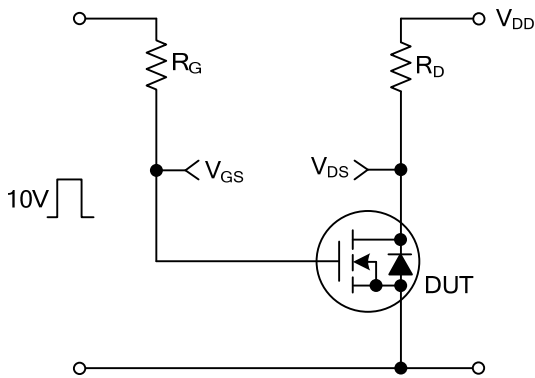
## TEST CIRCUITS AND WAVEFORMS



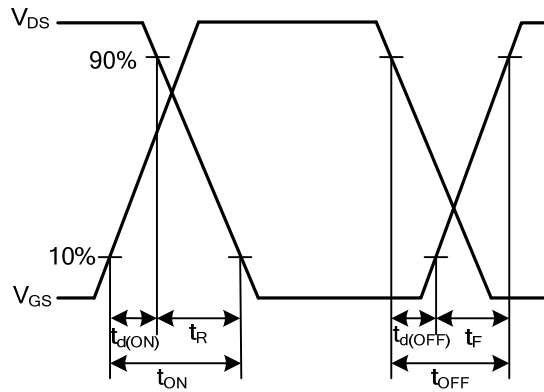
**Gate Charge Test Circuit**



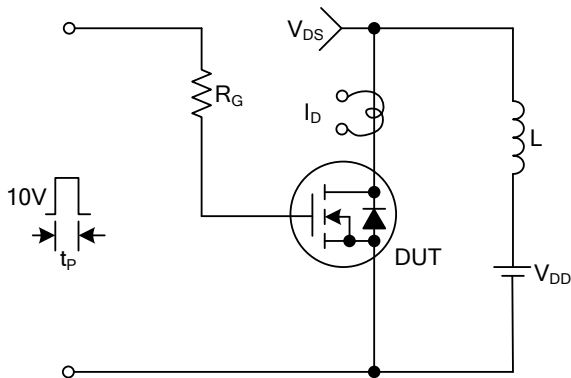
**Gate Charge Waveforms**



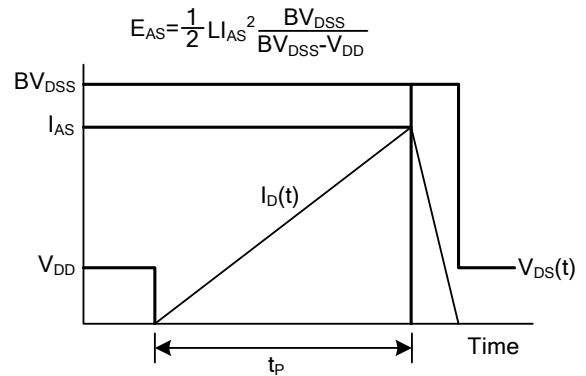
**Resistive Switching Test Circuit**



**Resistive Switching Waveforms**

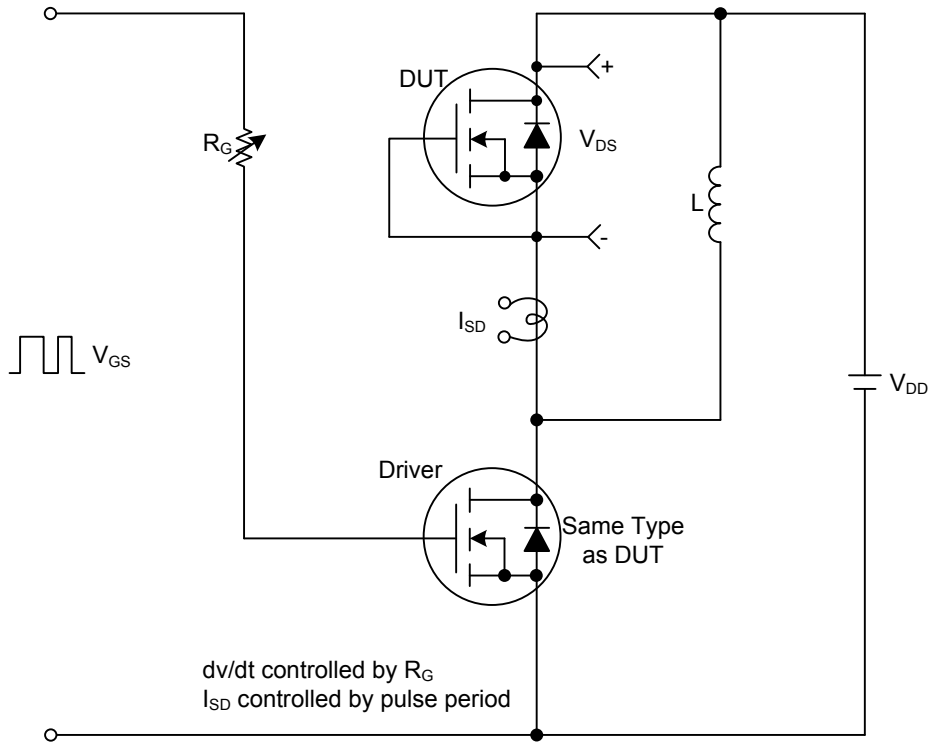


**Unclamped Inductive Switching Test Circuit**

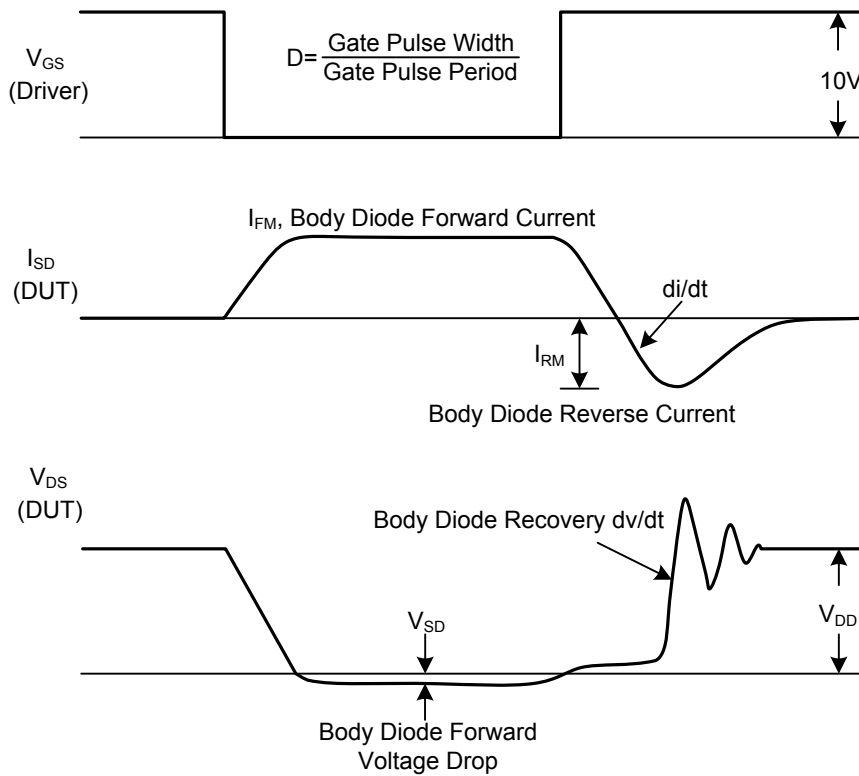


**Unclamped Inductive Switching Waveforms**

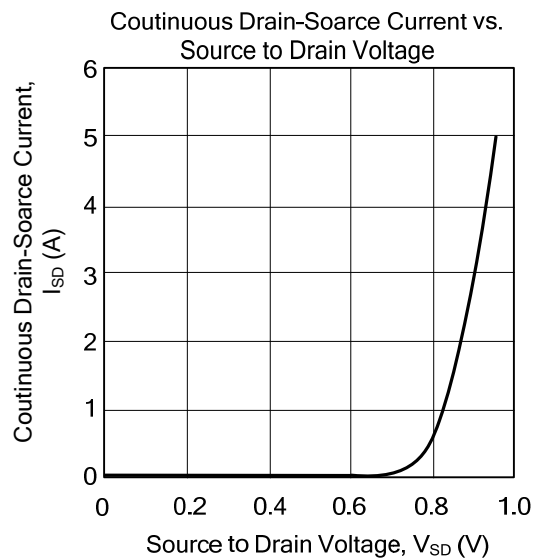
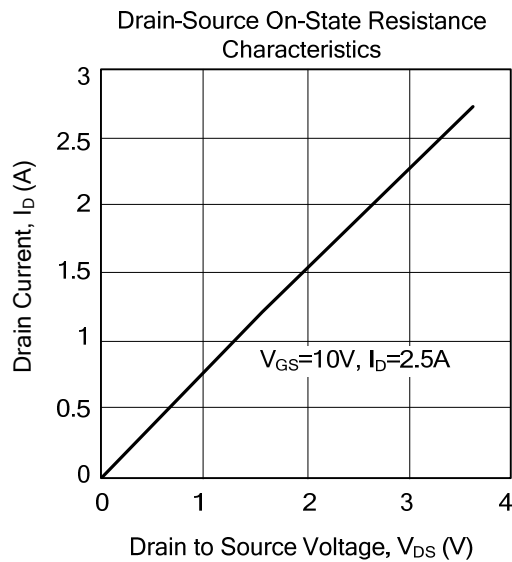
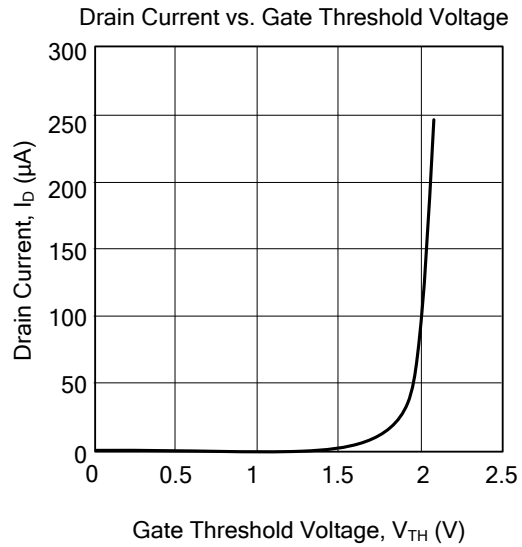
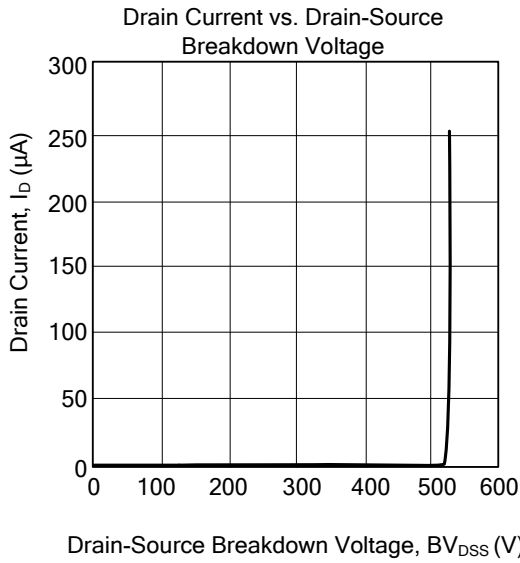
■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit & Waveforms



### TYPICAL CHARACTERISTICS



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